



## **OKI Semiconductor**

**FEDL6650DIGEST-05**Issue Date: Jan. 11, 2002

MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54-xx, MSM66P56-xx, MSM6650

Internal Mask ROM Voice Synthesis IC, Internal One-Time-Programmable (OTP) ROM Voice Synthesis IC, External ROM Drive Voice Synthesis IC

This document contains minimum specifications. For full specifications, please contact your nearest Oki office or representative.

#### **GENERAL DESCRIPTION**

The MSM6650 family is the successor to OKI's MSM6375 family. To ensure high-quality voice synthesis, the MSM6650 family members offer adaptive differential pulse-code modulation (ADPCM) playback, pulse-code modulation (PCM) playback, 12-bit D/A conversion, and on-chip –40 dB/octave low-pass filter (LPF).

The conventional "beep" tones and 2-channel playback are now easier to use. OKI has added additional functions such as melody play, fade-out, and random playback. OKI has improved external control by adding an Edit ROM. The Edit ROM can be used to form sentences by linking phrases.

The MSM6650 family members can support a variety of applications as it can function in either Standalone Mode or Microcontroller Interface Mode. In Microcontroller Interface Mode, serial input control is available. Serial input control minimizes the number of microcontroller port pins required for voice synthesis control. The MSM6650 family includes an internal mask ROM version, internal one-time-programmable (OTP) ROM version, and external ROM version. The features of the MSM6650 family devices are as follows.

#### • MSM6652/53/54/55/56-xxx

These devices are single-chip voice synthesizers with an on-chip mask ROM using the CMOS technology. Standalone Mode or Microcontroller Interface Mode can be selected by mask option.

#### • MSM6652A/53A/54A/55A/56A/58A-xxx

The trial production period for these devices is shorter than those described above. These devices are suitable for developing prototype models and concept demonstration of new products.

#### • MSM66P54-xx. MSM66P56-xx

The device is a single-chip CMOS voice synthesizer with one-time-programmable (OTP) ROM.

Standalone and Microcontroller Interface Modes are selected by using a code (01-04).

The user can easily write voice data using the development tool AR761 or AR762, or P54 adapter. Unlike the mask ROM version, the OTP version is suited to applications which requires a small lot production of different type devices or short delivery time.

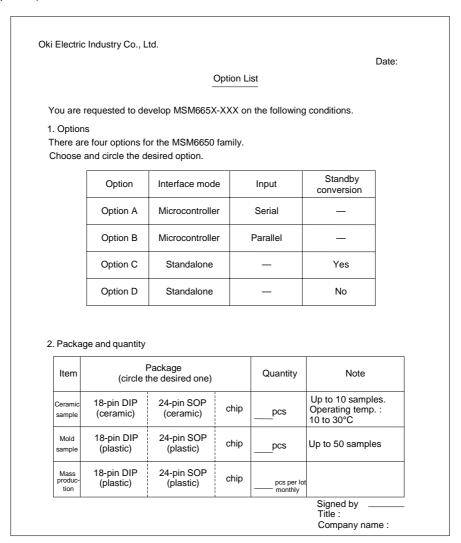
#### • MSM6650

The MSM6650 device can directly connect external ROM or EPROM of up to 64 Mbits, which stores voice data. This device is ideally suited to an evaluation IC for the MSM6650 family because its circuit configuration is identical to those of the mask ROM-based and OTP version devices.

#### • Option Table

	Din Nama	Microcontroller	interface Mode	Standalone Mode		
	Pin Name	Serial Input	Parallel Input	With Standby	No Standby	_
MSM6652/53/54/55/56 MSM6652A/53A/54A/ 55A/56A/58A	_		Mask Option			
MSM66P54/P56	_	-01	-02	-03	-04	*2
	CPU	"H"	"H"	"L"	"L"	_
MSM6650	SERIAL	"H"	"L"	"L"	"L"	_
	STBY		_	"L"	"H"	

- \*1. The options for the mask ROM-based devices are mask options. The user should send OKI an option list before starting development. A sample of option list is shown below.
- \*2. A code of OTP version device corresponds to one of the options. The user should specify either MSM66P54-03 or MSM66P54-04 or MSM66P56-03 or MSM66P56-04. (In this case, no option list is required.)



#### STANDALONE MODE

#### **FEATURES**

Davisa nama	ROM size	Maximum playback time (sec)						
Device name	ROW Size	$f_{SAM} = 4.0 \text{ kHz}$	$f_{SAM} = 6.4 \text{ kHz}$	$f_{SAM} = 8.0 \text{ kHz}$	f <sub>SAM</sub> = 16 kHz			
MSM6652, 6652A	288 Kbits	16.9	10.5	8.4	4.2			
MSM6653, 6653A	544 Kbits	31.2	19.5	15.6	7.8			
MSM6654, 6654A	1 Mbit	63.8	39.9	31.9	15.9			
MSM6655, 6655A	1.5 Mbits	96.5	60.3	48.2	24.1			
MSM6656, 6656A	2 Mbits	129.1	80.7	64.5	32.2			
MSM6658A	4 Mbits	259.7	162.9	129.8	64.9			
MSM66P54	1 Mbit	63.8	39.9	31.9	15.9			
MSM66P56	2 Mbit	129.1	80.7	64.5	32.2			
MSM6650	64 Mbits (Max)	4194.3	2620.5	2096.4	1048.2			

Note: Actual voice ROM area is smaller by 22 Kbits.

- 4-bit ADPCM or 8-bit PCM sound generation
- Melody function
- Edit ROM function
- Two-channel mixing function
- Built-in random playback function
- Fade-out function via four-step sound volume attenuation
- Built-in beep tone of 0.5 kHz, 1.0 kHz, 1.3 kHz, or 2.0 kHz selectable with a specific code
- Sampling frequency of 4.0 kHz, 5.3 kHz, 6.4 kHz, 8.0 kHz, 10.6 kHz, 12.8 kHz, 16.0 kHz, or 32.0 kHz (32 kHz sampling is not possible when using RC oscillation)
- Up to 120 phrases
- Built-in 12-bit D/A converter
- Built-in -40 dB/octave low-pass filter
- Standby function
- Selectable RC or ceramic oscillation
- Package options:

18-pin plastic DIP (DIP18-P-300-2.54) (Product name: MSM6652-xxxRS/MSM6653-xxxRS/

MSM6654-xxxRS/MSM6655-xxxRS/ MSM6656-xxxRS/MSM6652A-xxxRS/ MSM6653A-xxxRS/MSM6654A-xxxRS/ MSM6655A-xxxRS/MSM6656A-xxxRS/

MSM6658A-xxxRS)

24-pin plastic SOP (SOP24-P-430-1.27-K) (Product name: MSM6652-xxxGS-K/MSM6653-xxxGS-K/

MSM6654-xxxGS-K/MSM6655-xxxGS-K/ MSM6656-xxxGS-K/MSM6652A-xxxGS-K/ MSM6653A-xxxGS-K/MSM6654A-xxxGS-K/ MSM6655A-xxxGS-K/MSM6656A-xxxGS-K/ MSM6658A-xxxGS-K/MSM66P54-03GS-K/ MSM66P54-04GS-K/MSM66P56-03GS-K/

MSM66P56-04GS-K)

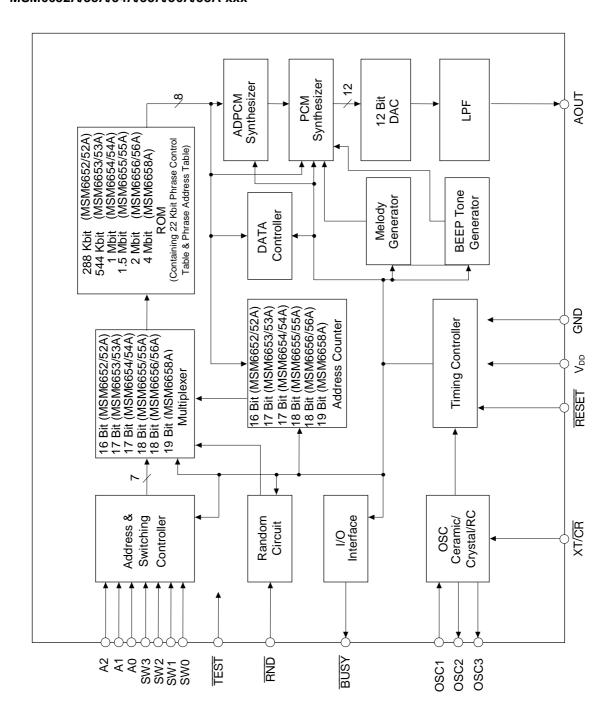
20-pin plastic DIP (DIP20-P-300-2.54-W1) (Product name: MSM66P54-03RS/MSM66P54-04RS/

MSM66P56-03RS/MSM66P56-04RS)

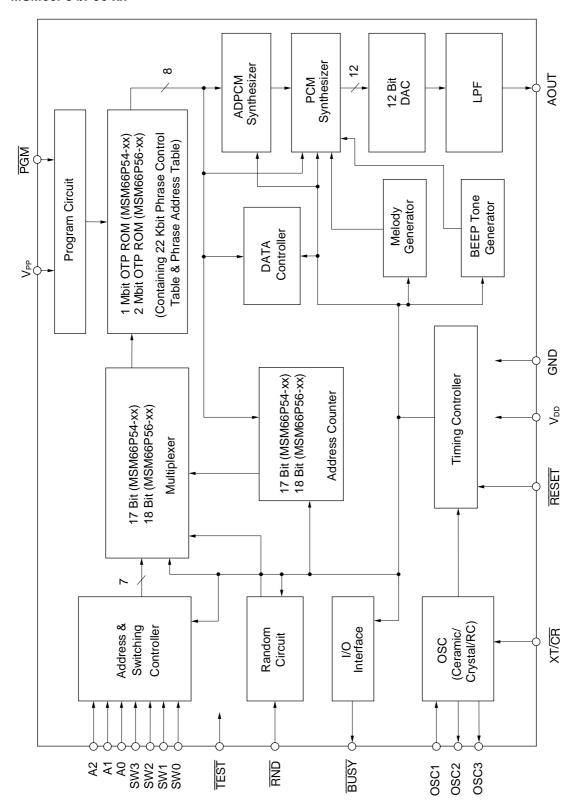
64-pin plastic QFP (QFP64-P-1420-1.00-BK) (Product name: MSM6650GS-BK) 64-pin plastic SDIP (SDIP64-P-750-1.778) (Product name: MSM6650SS)

#### **BLOCK DIAGRAMS**

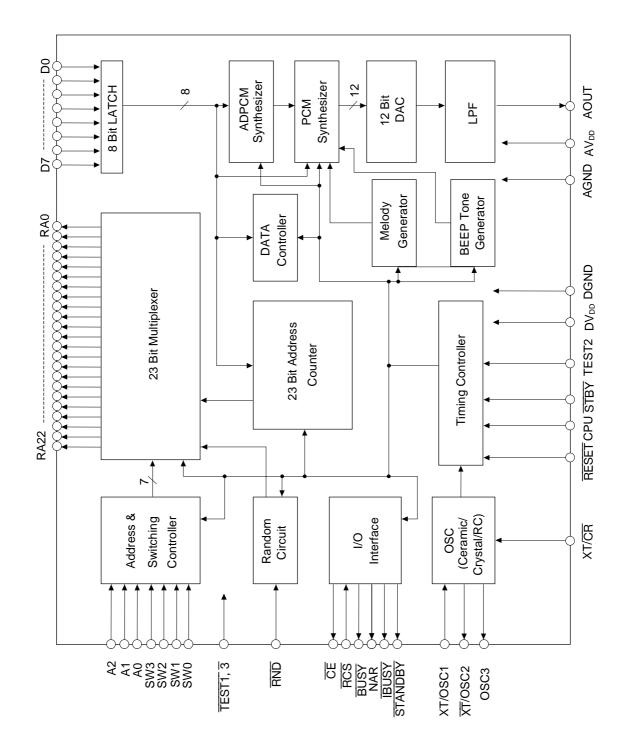
#### MSM6652/53/54/55/56-xxx MSM6652A/53A/54A/55A/56A/58A-xxx



## MSM66P54/P56-xx



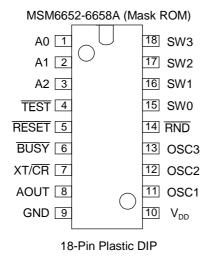
## MSM6650



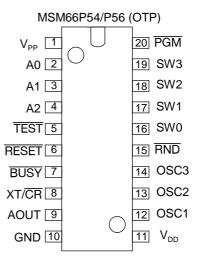
#### PIN CONFIGURATION (TOP VIEW)

The MSM66P54-xx and MSM66P56-xx has two more pins than the MSM6652-6658A while their pin configurations are identical.

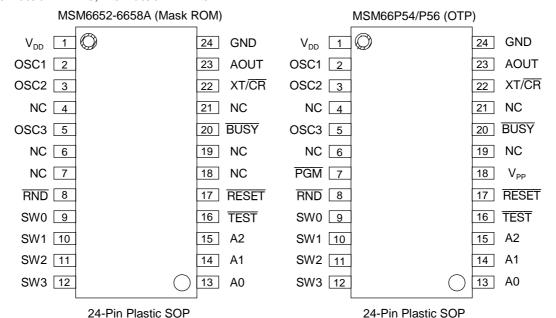
The additional two pins  $(V_{PP}, \overline{PGM})$  of the MSM66P54-xx/P56-xx may be open at playback after completion of writing.



MSM6652-xxxRS, MSM6653-xxxRS, MSM6654-xxxRS, MSM6655-xxxRS, MSM6656-xxxRS, MSM6652A-xxxRS, MSM6653A-xxxRS, MSM6654A-xxxRS, MSM6655A-xxxRS, MSM6656A-xxxRS, MSM665A-xxxRS, MSM665A-xxxXS, MSM665A-xxxXS,



20-Pin Plastic DIP MSM66P54-03/-04RS MSM66P56-03/-04RS



SM66P54-03/-04GS-K

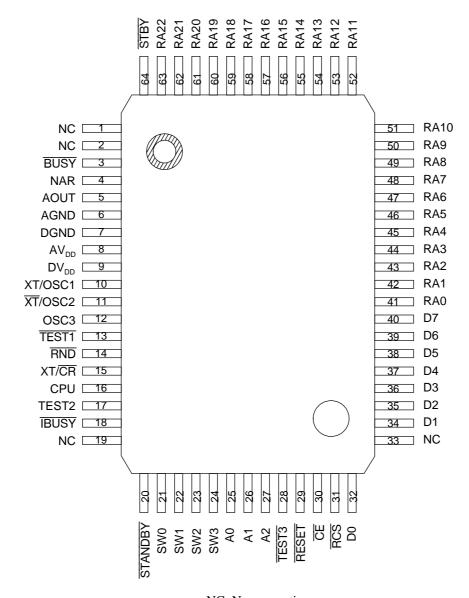
MSM66P56-03/-04GS-K

SM6652-xxxGS-K, MSM6653-xxxGS-K, MSM6654-xxxGS-K, MSM6655-xxxGS-K, MSM6656-xxxGS-K, MSM6652A-xxxGS-K, MSM6653A-xxxGS-K, MSM6654A-xxxGS-K, MSM6655A-xxxGS-K, MSM6656A-xxxGS-K, MSM6658A-xxxGS-K

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#### MSM6650

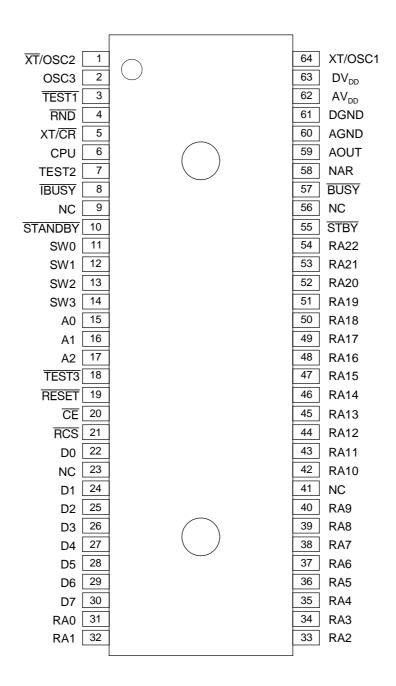
Product name: MSM6650GS-BK



NC: No connection

64-Pin Plastic QFP

Product name: MSM6650SS



NC: No connection

64-Pin Plastic SDIP

## PIN DESCRIPTIONS

## 1. MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx 18-Pin plastic DIP

Pin	Symbol	Туре	Description
5	RESET	I	Reset. Setting this pin to "L" puts the LSI In standby status. At this time, oscillation stops, AOUT is pulled to GND, and the deveice is initialized. This pin has an internal pull-up resistor.
6	BUSY	0	Busy. This pin outputs a "L" level during playback. At power-on, this pin Is at "H" level.
7	XT/CR	I	XT/CR selectable pin. Set to "H" level when using ceramic oscillation. Set to "L" level when using RC oscillation.
8	AOUT	0	Sound Output. This is the synthesized output pin of the internal low-pass filter.
11	OSC1	I	Oscillator 1. This pin is a ceramic oscillator connection pin when using ceramic oscillation. This pin is an RC connection pin when using RC oscillation. When using an external clock, use this pin as the clock input.
12	OSC2	0	Oscillator 2. This pin is a ceramic oscillator connection pin when using a ceramic oscillator. This is an RC connection pin when using RC oscillation. Leave open if using an external clock. OSC2 outputs a "L" level in standby status.
13	OSC3	0	Oscillator 3. Leave open if using a ceramic oscillator. This pin is the RC connection pin when using RC oscillation. When RC oscillation is selected, OSC3 outputs a "H" level in standby status.
14	RND	I	Random Playback. Random playback starts when the $\overline{\text{RND}}$ pin is set to a "L" level. At the fall of $\overline{\text{RND}}$ , addresses from the random address playback circuit inside the IC are fetched. Set to a "H" level if random playback is not used. This pin has an Internal pull-up resistor.
15-18	SW0-SW3	I	Phrase Inputs. These pins are phrase input pins corresponding to playback. If the Input changes, SW0 to SW3 pins capture address data after 16 ms and speech playback commences. These pins have internal pull-down resistors.
1-3	A0-A2	I	Phrase Inputs. Phrase input pins correspoding to playback. The A0 input becomes invalid when the random playback function is used.
9	GND	_	Ground.
10	$V_{DD}$		Power supply. Insert a 0.1 $\mu\text{F}$ or more bypass capacitor between this pin and GND.
4	TEST	I	Test Mode. Set to "H" level. This pin has an Internal pull-up resistor

# 2. MSM66P54-xx, MSM66P56-xx 20-Pin plastic DIP

Pin	Symbol	Туре	Description
6	RESET	I	Reset. Setting this pin to "L" puts the LSI in standby status. At this time, oscillation stops, AOUT is pulled to GND, and the deveice is initialized. This pin has an internal pull-up resistor.
7	BUSY	0	Busy. This pin outputs a "L" level during playback. At power-on, this pin Is at "H" level.
8	XT/CR	I	XT/CR selectable pin. Set to "H" level when using ceramic oscillation. Set to "L" level when using RC oscillation.
9	AOUT	0	Sound Output. This is the synthesized output pin of the internal low-pass filter.
12	OSC1	I	Oscillator 1. This pin is a ceramic oscillator connection pin when using ceramic oscillation. This pin is an RC connection pin when using RC oscillation. When using an external clock, use this pin as the clock input.
13	OSC2	0	Oscillator 2. This pin Is a ceramic oscillator connection pin when using a ceramic oscillator. This is an RC connection pin when using RC oscillation. Leave open if using an external clock. OSC2 outputs a "L" level in standby status.
14	OSC3	0	Oscillator 3. Leave open if using a ceramic oscillator. This pin is the RC connection pin when using RC oscillation. When RC oscillation is selected, OSC3 outputs a "H" level In standby status.
15	RND	ı	Random Playback. Random playback starts when the $\overline{\text{RND}}$ pin is set to a "L" level. At the fall of $\overline{\text{RND}}$ , addresses from the random address playback circuit inside the IC are fetched. Set to a "H" level if random playback is not used. This pin has an Internal pull-up resistor.
16-19	SW0-SW3	I	Phrase Inputs. These pins are phrase Input pins corresponding to playback. If the Input changes, SW0 to SW3 pins capture address data after 16 ms and speech playback commences. These pins have internal pull-down resistors.
2-4	A0-A2	I	Phrase Inputs. Phrase input pins correspoding to playback. The A0 input becomes invalid when the random playback function is used.
10	GND	_	Ground.
11	$V_{DD}$	_	Power supply. Insert a 0.1 $\mu\text{F}$ or more bypass capacitor between this pin and GND.
5	TEST	I	Test Mode. Set to "H" level. This pin has an Internal pull-up resistor.
1	V <sub>PP</sub>	_	Power supply used when writing data to Internal OTP ROM. Leave open or set to "H" level during playback.
20	PGM	I	Interface with voice analysis edit tool AR203 or AR204. Set to "L" level or leave open during playback.

## 3. MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54-xx, MSM66P56-xx 24-Pin plastic SOP

Pin	Symbol	Туре	Description
17	RESET	I	Reset. Setting this pin to "L" puts the LSI in standby status. At this time, oscillation stops, AOUT is pulled to GND, and the deveice is initialized. This pin has an internal pull-up resistor.
20	BUSY	0	Busy. This pin outputs a "L" level during playback. At power-on, this pin Is at "H" level.
22	XT/CR	-	XT/CR selectable pin. Set to "H" level when using ceramic oscillation. Set to "L" level when using RC oscillation.
23	AOUT	0	Sound Output. This is the synthesized output pin of the internal low-pass filter.
2	OSC1	I	Oscillator 1. This pin is a ceramic oscillator connection pin when using ceramic oscillation. This pin is an RC connection pin when using RC oscillation.  When using an external clock, use this pin as the clock input.
3	OSC2	0	Oscillator 2. This pin Is a ceramic oscillator connection pin when using a ceramic oscillator. This is an RC connection pin when using RC oscillation. Leave open if using an external clock. OSC2 outputs a "L" level in standby status.
5	OSC3	0	Oscillator 3. Leave open if using a ceramic oscillator. This pin is the RC connection pin when using RC oscillation. When RC oscillation is selected, OSC3 outputs a "H" level In standby status.
8	RND	I	Random Playback. Random playback starts when the $\overline{\text{RND}}$ pin is set to a "L" level. At the fall of $\overline{\text{RND}}$ , addresses from the random address playback circuit inside the IC are fetched. Set to a "H" level if random playback is not used. This pin has an Internal pull-up resistor.
9-12	SW0-SW3	I	Phrase Inputs. These pins are phrase Input pins corresponding to playback. If the Input changes, SW0 to SW3 pins capture address data after 16 ms and speech playback commences. These pins have internal pull-down resistors.
13-15	A0-A2	-	Phrase Inputs. Phrase input pins correspoding to playback. The A0 input becomes invalid when the random playback function is used.
24	GND		Ground.
1	V <sub>DD</sub>		Power supply. Insert a 0.1 $\mu\text{F}$ or more bypass capacitor between this pin and GND.
16	TEST	I	Test Mode. Set to "H" level. This pin has an Internal pull-up resistor.
18	V <sub>PP</sub> *	_	Power supply used when writing data to Internal OTP ROM. Leave pen or set to "H" level during playback.
7	PGM*	I	Interface with voice analysis edit tool AR203 or AR204. Set to "L" level or leave open during playback.

<sup>\*</sup> Pins for MSM66P54/56-xx only

## 4. MSM6650 64-Pin plastic QFP (64-Pin plastic SDIP)

Pin	Symbol	Туре	Description
29 (19)	RESET	I	Reset. Setting this pin to "L" puts the LSI in standby status. At this time, oscillation stops, AOUT is pulled to GND, and the deveice is initialized. This pin has an internal pull-up resistor.
3 (57)	BUSY	0	Busy. This pin outputs a "L" level during playback. At power-on, this pin Is at "H" level.
15 (5)	XT/CR	ı	XT/CR selectable pin. Set to "H" level when using ceramic oscillation. Set to "L" level when using RC oscillation.
5 (59)	AOUT	0	Sound Output. This is the synthesized output pin of the internal low-pass filter.
10 (64)	XT/OSC1	I	Oscillator 1. This pin is a ceramic oscillator connection pin when using ceramic oscillation. This pin is an RC connection pin when using RC oscillation. When using an external clock, use this pin as the clock input.
11 (1)	XT/OSC2	0	Oscillator 2. This pin Is a ceramic oscillator connection pin when using a ceramic oscillator. This is an RC connection pin when using RC oscillation. Leave open if using an external clock. OSC2 outputs a "L" level in standby status.
12 (2)	OSC3	0	Oscillator 3. Leave open if using a ceramic oscillator. This pin is the RC connection pin when using RC oscillation. When RC oscillation is selected, OSC3 outputs a "H" level In standby status.
14 (4)	RND	I	Random Playback. Random playback starts when the $\overline{\text{RND}}$ pin is set to a "L" level. At the fall of $\overline{\text{RND}}$ , addresses from the random address playback circuit inside the IC are fetched. Set to a "H" level if random playback is not used. This pin has an Internal pull-up resistor.
21-24 (11-14)	SW0-SW3	I	Phrase Inputs. These pins are phrase Input pins corresponding to playback. If the input changes, SW0 to SW3 pins capture address data after 16 ms and speech playback commences. These pins have internal pull-down resistors.
25-27 (15-17)	A0-A2	I	Phrase Inputs. Phrase input pins correspoding to playback. The A0 input becomes invalid when the random playback function is used.

maintains half V<sub>DD</sub> after voice ends.

**OKI Semiconductor** 

## ABSOLUTE MAXIMUM RATINGS

(GND = 0 V)

Parameter	Parameter Symbol		Rating	Unit
Power supply voltage	$V_{DD}$	T- 25°C	-0.3 to +7.0	V
Input voltage	V <sub>IN</sub>	Ta = 25°C	$-0.3$ to $V_{DD} + 0.3$	V
Storage temperature	T <sub>STG</sub>	_	-55 to +150	°C

## RECOMMENDED OPERATING CONDITIONS

(GND = 0 V)

Parameter	Symbol	Condition		Range		
Power supply voltage	V <sub>DD</sub>	MSM6652-56, MSM6650, MSM6652A-56A		2.4 to 5.5		V
	V <sub>DD</sub>	MSM6658A, MSM66P54/P56	3.5 to 5.5		V	
Operating temperature	T <sub>OP</sub>	_		-40 to +85		
Mantan alask francisco acid	f <sub>OSC1</sub>	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	Min.	Тур.	Max.	N 41 1-
Master clock frequency 1		When crystal selected	3.5	4.096	4.5	MHz
Master clock frequency 2	f <sub>OSC2</sub>	When RC selected (*)	200	256	300	kHz

<sup>\*</sup> If RC oscillation is selected, 32 kHz sampling frequency cannot be selected.

## **ELECTRICAL CHARACTERISTICS**

## **DC** Characteristics

 $(V_{DD} = 5.0 \text{ V}, \text{GND} = 0 \text{ V}, \text{Ta} = -40 \text{ to } +85^{\circ}\text{C})$ 

			1 00			
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
"H" input voltage	V <sub>IH</sub>	_	4.2	_	_	V
"L" input voltage	V <sub>IL</sub>	_	_	_	0.8	V
"H" output voltage	V <sub>OH</sub>	$I_{OH} = -1 \text{ mA}$	4.6	_	_	V
"L" output voltage	V <sub>OL</sub>	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V
"H" input current 1	I <sub>IH1</sub>	V <sub>IH</sub> = V <sub>DD</sub> — —		_	10	μΑ
"H" input current 2	I <sub>IH2</sub>	Internal pull-down		90	200	μΑ
"L" input current 1	I <sub>IL1</sub>	V <sub>IL</sub> = GND	-10	_	_	μΑ
"L" input current 2 (note)	I <sub>IL2</sub>	Internal pull-up resistance	-200 -90		-30	μΑ
Operating power consumption	I <sub>DD</sub>	_		6	10	mA
Standby power		Ta = $-40$ °C to $+50$ °C	_	_	10	μΑ
consumption	I <sub>DS</sub>	$Ta = -40^{\circ}C \text{ to } +85^{\circ}C$	_	_	30	μΑ

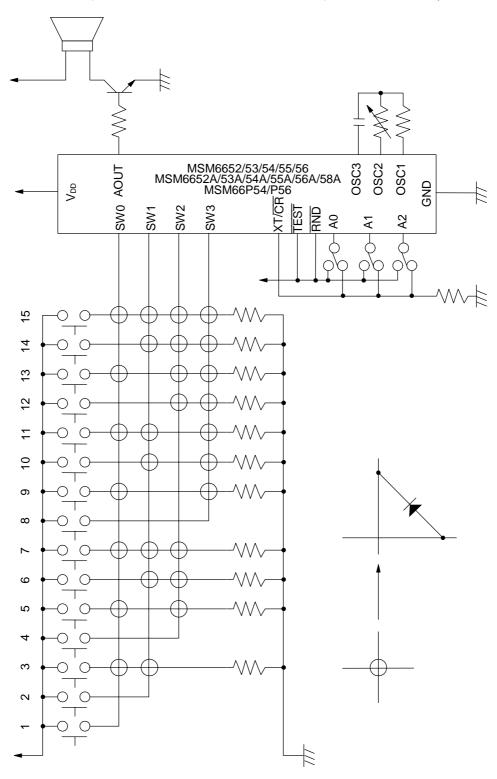
## **DC** Characteristics

 $(V_{DD} = 3.1 \text{ V, GND} = 0 \text{ V, Ta} = -40 \text{ to } +85^{\circ}\text{C})$ 

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
"H" input voltage	V <sub>IH</sub>	_	2.7	_	_	V
"L" input voltage	V <sub>IL</sub>	_	_	_	0.5	V
"H" output voltage	V <sub>OH</sub>	$I_{OH} = -1 \text{ mA}$	2.6	1	_	V
"L" output voltage	V <sub>OL</sub>	$I_{OL} = 2 \text{ mA}$	I	1	0.4	V
"H" input current 1	I <sub>IH1</sub>	$V_{IH} = V_{DD}$	ı	1	10	μΑ
"H" input current 2	I <sub>IH2</sub>	Internal pull-down resistance 10 30		30	100	μΑ
"L" input current 1	I <sub>IL1</sub>	$V_{IL} = GND$	-10	1	_	μΑ
"L" input current 2	I <sub>IL2</sub>	Internal pull-up resistance	-100   -30		-10	μΑ
Operating power consumption	I <sub>DD</sub>	_	_	4	7	mA
Standby power		Ta = $-40$ °C to $+50$ °C	_	_	5	μΑ
consumption	I <sub>DS</sub>	Ta = $-40$ °C to $+85$ °C			20	μΑ
LPF driving resistance	R <sub>AOUT</sub>	When LPF output is selected	50	_	_	kΩ
LPF output impedance	$R_{LPF}$	I <sub>F</sub> = 100 μA	_	1	3	kΩ

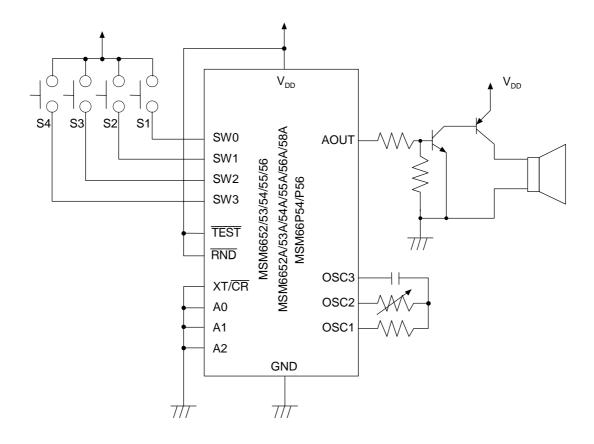
## **APPLICATION CIRCUITS**

(MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54/P56-xx)



Application Circuit in Standalone Mode Supporting 15 Switch-Selected Phrases

(MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54/P56-xx)

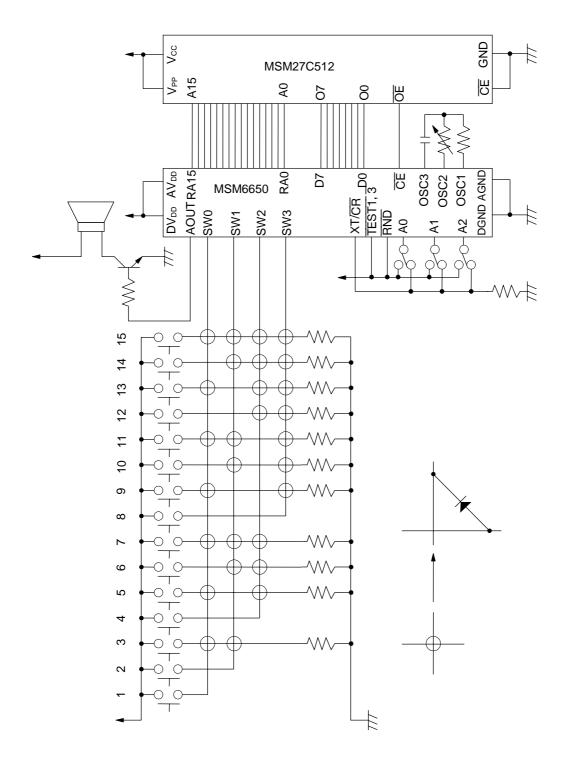


**Application Circuit in Standalone Mode Supporting Four Switch-Selected Words** 

## **Switches and Playback Addresses**

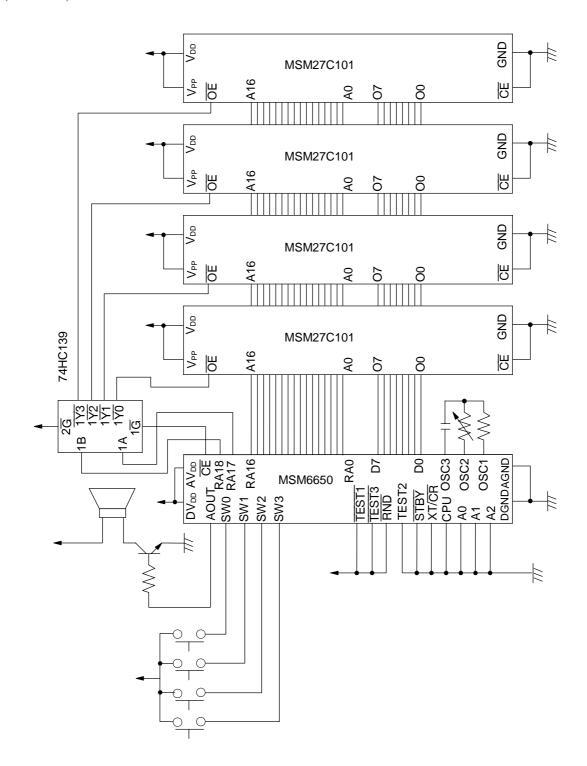
	A2	A1	A0	SW3	SW2	SW1	SW0	ADR
S1	0	0	0	0	0	0	1	01
S2	0	0	0	0	0	1	0	02
S3	0	0	0	0	1	0	0	04
S4	0	0	0	1	0	0	0	08

## (MSM6650)



**Application Circuit in Standalone Mode Supporting 15 Switch-Selected Phrases** 

## (MSM6650)



**Application Circuit in Standalone Mode Supporting Four 1 Mbit EPROMs** 

#### MICROCONTROLLER INTERFACE MODE

#### **FEATURES**

	DATA DOM	Maximum playback time (sec)						
Device name	DATA ROM size	f <sub>SAM</sub> = 4.0 kHz	f <sub>SAM</sub> = 6.4 kHz	$f_{SAM} = 8.0$ kHz	f <sub>SAM</sub> = 16 kHz	f <sub>SAM</sub> = 32 kHz		
MSM6652, 6652A	288 Kbits	16.9	10.5	8.4	4.2	2.1		
MSM6653, 6653A	544 Kbits	31.2	19.5	15.6	7.8	3.9		
MSM6654, 6654A	1 Mbit	63.8	39.9	31.9	15.9	7.9		
MSM6655, 6655A	1.5 Mbits	96.5	60.3	48.2	24.1	12.0		
MSM6656, 6656A	2 Mbits	129.1	80.7	64.5	32.2	16.1		
MSM6658A	4 Mbits	259.7	162.9	129.8	64.9	32.4		
MSM66P54	1 Mbit	63.8	39.9	31.9	15.9	7.9		
MSM66P56	2 Mbit	129.1	80.7	64.5	32.2	16.1		
MSM6650	64 Mbits (Max)	4194.3	2620.5	2096.4	1048.2	524.1		

Note: Actual voice ROM area is smaller by 22 Kbits.

- 4-bit ADPCM or 8-bit PCM sound generation
- Melody function
- Edit ROM function
- Two-channel mixing function
- Fade-out function via four-step sound volume attenuation
- Serial input or parallel input selectable
- Built-in beep tone of 0.5 kHz, 1.0 kHz, 1.3 kHz, or 2.0 kHz selectable with a specific code
- Sampling frequency of 4.0 kHz, 5.3 kHz, 6.4 kHz, 8.0 kHz, 10.6 kHz, 12.8 kHz, 16.0 kHz, or 32.0 kHz (32 kHz sampling is not possible when using RC oscillation)
- Up to 127 phrases
- Built-in 12-bit D/A converter
- Built-in -40 dB/octave low-pass filter
- Standby function
- Package options:

18-pin plastic DIP (DIP18-P-300-2.54) (Product name: MSM6652-xxxRS/MSM6653-xxxRS/

MSM6654-xxxRS/MSM6655-xxxRS/ MSM6656-xxxRS/MSM6652A-xxxRS/ MSM6653A-xxxRS/MSM6654A-xxxRS/ MSM6655A-xxxRS/MSM6656A-xxxRS/

MSM6658A-xxxRS)

24-pin plastic SOP (SOP24-P-430-1.27-K) (Product name: MSM6652-xxxGS-K/MSM6653-xxxGS-K/

MSM6654-xxxGS-K/MSM6655-xxxGS-K/ MSM6656-xxxGS-K/MSM6652A-xxxGS-K/ MSM6653A-xxxGS-K/MSM6654A-xxxGS-K/ MSM6655A-xxxGS-K/MSM6656A-xxxGS-K/ MSM6658A-xxxGS-K/MSM66P54-01GS-K/ MSM66P54-02GS-K/MSM66P56-01GS-K/

MSM66P56-02GS-K)

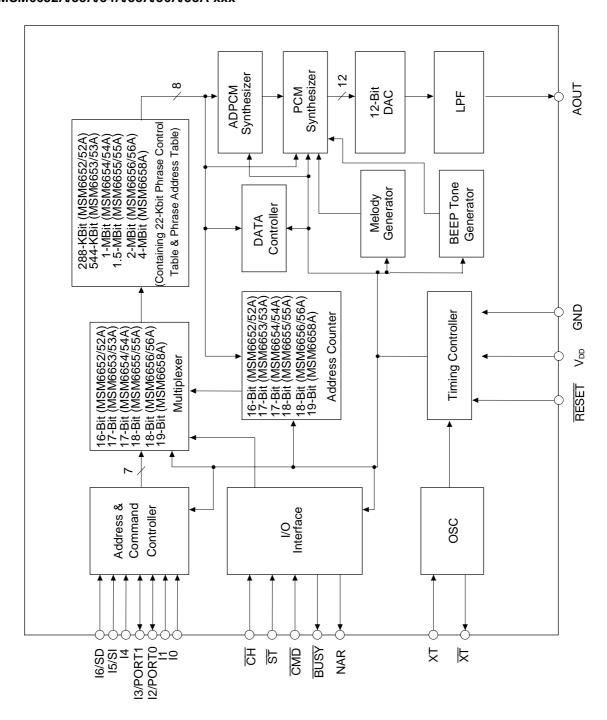
20-pin plastic DIP (DIP20-P-300-2.54-W1) (Product name: MSM66P54-01RS/MSM66P54-02RS/

MSM66P56-01RS/MSM66P56-02RS)

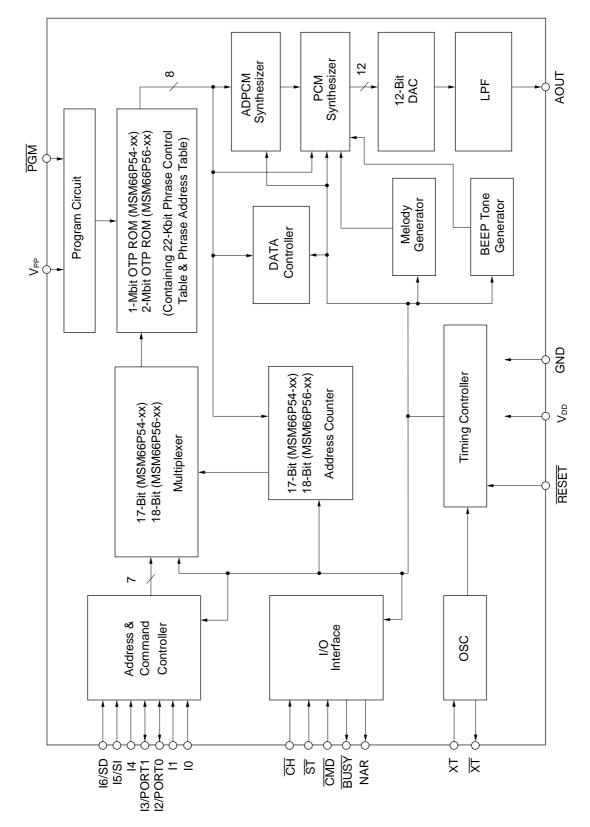
64-pin plastic QFP (QFP64-P-1420-1.00-BK) (Product name: MSM6650GS-BK) 64-pin plastic SDIP (SDIP64-P-750-1.778) (Product name: MSM6650SS)

#### **BLOCK DIAGRAMS**

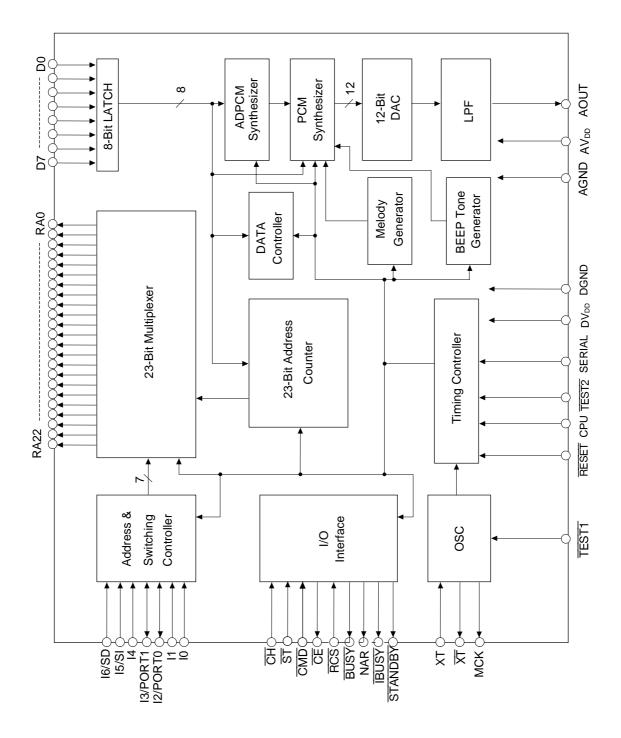
#### MSM6652/53/54/55/56-xxx MSM6652A/53A/54A/55A/56A/58A-xxx



## MSM66P54/P56-xx

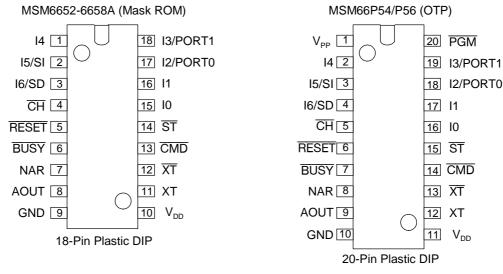


## MSM6650



#### PIN CONFIGURATION (TOP VIEW)

The MSM66P54/P56-xx has two more pins than the MSM66S2-6658A while their pin configurations are identical. The additional two pins  $(V_{PP}, \overline{PGM})$  of the MSM66P54/P56-xx may be open at playback after completion of writing.



MSM6652-xxxRS, MSM6653-xxxRS, MSM6654-xxxRS, MSM6655-xxxRS, MSM6656-xxxRS, MSM6652A-xxxRS, MSM6653A-xxxRS, MSM6653A-xxxRS, MSM6653A-xxxRS, MSM6654A-xxxRS, MSM6656A-xxxRS, MSM665A-xxxRS, MSM665A-xxxRS

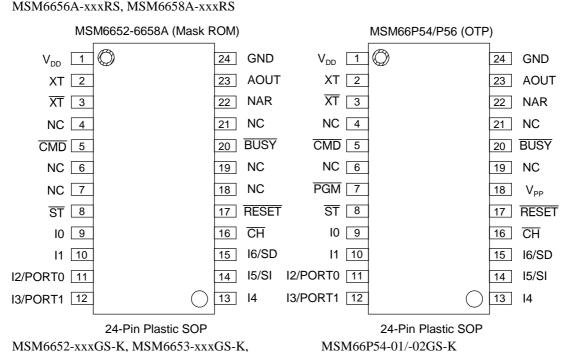
MSM6654-xxxGS-K, MSM6655-xxxGS-K,

MSM6658A-xxxGS-K

MSM6656-xxxGS-K, MSM6652A-xxxGS-K, MSM6653A-xxxGS-K, MSM6654A-xxxGS-K, MSM6656A-xxxGS-K, MSM6656A-xxxGS-K,

MSM66P54-01/-02RS MSM66P56-01/-02RS

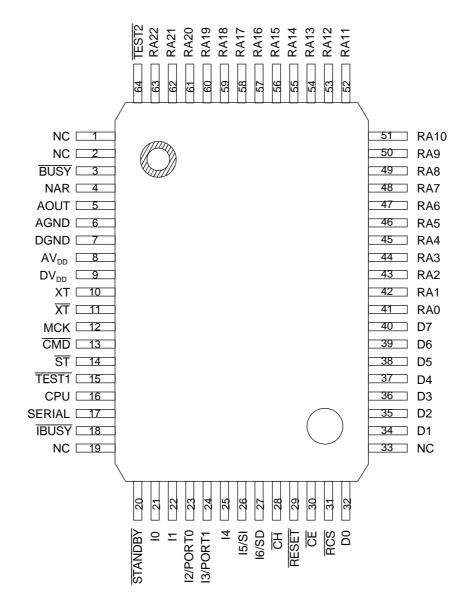
MSM66P56-01/-02GS-K



25/46

#### MSM6650

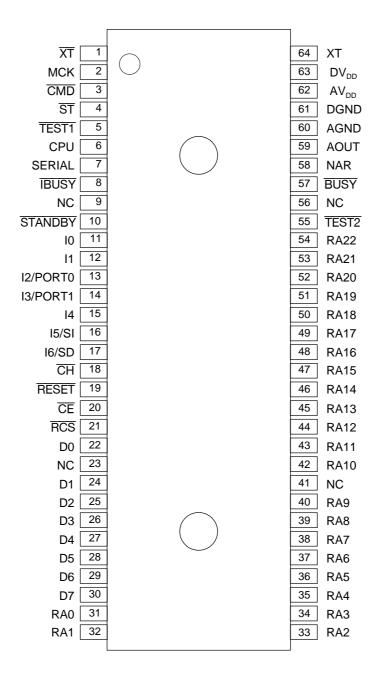
Product name: MSM6650GS-BK



NC: No connection

64-Pin Plastic QFP

Product name: MSM6650SS



NC: No connection

**64-Pin Plastic SDIP** 

## PIN DESCRIPTIONS

## 1. MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx 18-Pin plastic DIP

Pin	Symbol	Туре	Description
5	RESET	1	Reset. The devices enter stanby status when a low level is input to this pin. When RESET, oscillation stops The AOUT output goes to ground and the IC status is reinitialzed. This pin has an internal pull-up resistor.
6	BUSY	0	Busy. Outputs a "L" level during playback and a "H" level when power is turned ON.
7	NAR	0	The CMD and ST inputs become effective when high. NAR indicates whether the address bus (10 through 16) is ready to accept another address. When high, it is ready to accept. NAR goes high when power is turned ON.
8	AOUT	0	Analog Speech Output. D/A converter output or LPF output is selected by entering the command.
11	XT	I	Ceramic Oscillator Input. This pin has an internal 0.5 to 5 M $\Omega$ feedback resistor between XT and $\overline{\text{XT}}$ . If an external clock is used, this is the clock input pin.
12	XT	0	Ceramic Oscillator Output. If an external clock is used, leave this pin open.
13	CMD	I	Command Input and Option Control. This pin is used as command and option input when CMD is at the high level with $\overline{ST}$ low. If this pin is not used or serial input is optioned, set this pin to "H" level This pin has an Internal pull up resistor.
14	ST	I	Start. Speech playback starts at the fall of the $\overline{ST}$ pulse. The 10-16 addresses are latched at the rise of the $\overline{ST}$ pulse. Input a $\overline{ST}$ pulse when NAR goes to the high level for channels 1 and 2. This pin has an internal pull-up resistor.
4	CH	I	Channel Control. Channel 1 is selected when the input Is pulled high. Channel 2 is selected when the Input is low. This pin has an internal pull-up resistor.
3	I6/SD	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is serial data (command and address) input when serial input is optioned.
2	I5/SI	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is used as serial clock input when serial input is optioned.
1	14	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.
18	I3/PORT1	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.
17	I2/PORT0	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.
15, 16	10, 11	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.
9	GND	_	Ground pin.
10	V <sub>DD</sub>		Power supply. Insert a 0.1 $\mu\text{F}$ ro more bypass capacitor between this pin and GND.

## 2. MSM66P54/P56-xx 20-Pin plastic DIP

Pin	Symbol	Туре	Description			
6	RESET	I	Reset. The devices enter stanby status when a low level is input to this pin. When RESET, oscillation stops. The AOUT output goes to ground and the IC status is reinitialized This pin has an internal pull-up resistor.			
7	BUSY	0	Busy. Outputs a "L" level during playback and a "H" level when power is turned ON.			
8	NAR	0	The CMD and ST inputs become effective when high. NAR indicates whether the address bus (10 through 16) is ready to accept another address. When high, it is ready to accept. NAR goes high when power is turned ON.			
9	AOUT	0	Analog Speech Output. D/A converter output or LPF output is selected by entering the command.			
12	XT	I	Ceramic Oscillator Input. This pin has an internal 0.5 to 5 M $\Omega$ feedback resistor between XT and $\overline{\text{XT}}$ . If an external clock is used, this is the clock input pin.			
13	XT	0	Ceramic Oscillator Output. If an external clock is used, leave this pin open.			
14	CMD	I	Command Input and Option Control. This pin is used as command and option input when CMD is at the high level with $\overline{ST}$ low. If this pin is not used or serial input is optioned, set this pin to "H" level. This pin has an internal pull-up resistor.			
15	ST	ı	Start. Speech playback starts at the fall of the $\overline{ST}$ pulse. The 10-16 addresses are latched at the rise of the $\overline{ST}$ pulse. Input a $\overline{ST}$ pulse when NAR goes to the high level for channels 1 and 2. This pin has an internal pull-up resistor.			
5	CH	I	Channel Control. Channel 1 is selected when the input is pulled high. Channel 2 is selected when the input is low. This pin has an internal pull-up resistor.			
4	I6/SD	ı	This pin is command and user-defined phrase input when parallel input is optioned. This pin is serial data (command and address) input when serial input is optioned.			
3	I5/SI	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is used as serial clock input when serial input is optioned.			
2	14	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.			
19	I3/PORT1	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.			
18	I2/PORT0	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.			
16, 17	10, 11	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.			
10	GND		Ground pin.			
11	V <sub>DD</sub>	_	Power supply. Insert a 0.1 $\mu\text{F}$ ro more bypass capacitor between this pin and GND.			
1	V <sub>PP</sub>	_	Supply voltage for writing data to internal OTP ROM.			
20	PGM	I	Interface with voice analysis edit tools AR203 and AR204. Set to "L" level or leave open during playback. This pin has an internal pull-down resistor.			

## 3. MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54/P56-xx 24-Pin plastic SOP

Pin	Symbol	Туре	Description
17	RESET	I	Reset. The devices enter stanby status when a low level is input to this pin. When RESET, oscillation stops. The AOUT output goes to ground and the IC status is reinitialized This pin has an internal pull-up resistor.
20	BUSY	0	Busy. Outputs a "L" level during playback and a "H" level when power is turned ON.
22	NAR	0	The CMD and ST inputs become effective when high. NAR indicates whether the address bus (10 through 16) is ready to accept another address. When high, it is ready to accept. NAR goes high when power is turned ON.
23	AOUT	0	Analog Speech Output. D/A converter output or LPF output is selected by entering the command.
2	XT	I	Ceramic Oscillator Input. This pin has an internal 0.5 to 5 M $\Omega$ feedback resistor between XT and $\overline{\text{XT}}$ . If an external clock is used, this is the clock input pin.
3	XT	0	Ceramic Oscillator Output. If an external clock is used, leave this pin open.
5	CMD	I	Command Input and Option Control. This pin is used as command and option input when CMD is at the high level with $\overline{ST}$ low. If this pin is not used or serial input is optioned, set this pin to "H" level. This pin has an internal pull-up resistor.
8	ST	I	Start. Speech playback starts at the fall of the $\overline{ST}$ pulse. The 10-16 addresses are latched at the rise of the $\overline{ST}$ pulse. Input a $\overline{ST}$ pulse when NAR goes to the high level for channels 1 and 2. This pin has an internal pull-up resistor.
16	CH	I	Channel Control. Channel 1 is selected when the input is pulled high. Channel 2 is selected when the input is low. This pin has an internal pull-up resistor.
15	I6/SD	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is serial data (command and address) input when serial input is optioned.
14	I5/SI	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is used as serial clock input when serial input is optioned.
13	14	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.
12	I3/PORT1	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.
11	I2/PORT0	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.

Pin	Symbol	Туре	Description
9, 10	10, 11	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.
24	GND	_	Ground pin.
1	$V_{DD}$	_	Power supply. Insert a 0.1 $\mu\text{F}$ ro more bypass capacitor between this pin and GND.
18	V <sub>PP</sub> *	_	Supply voltage for writing data to internal OTP ROM.
7	PGM *	I	Interface with voice analysis edit tools AR761 and AR762. Set to "L" level or leave open during playback. This pin has an internal pull-down resistor.

<sup>\*</sup> Pins for MSM66P54/56-xx only

## 4. MSM6650 64-Pin plastic QFP (64-Pin plastic SDIP)

Pin	Symbol	Туре	Description
29 (19)	RESET	I	Reset. The devices enter stanby status when a low level is input to this pin. When RESET, oscillation stops The AOUT output goes to ground and the IC status is reinitialized. This pin has an internal pull-up resistor.
3 (57)	BUSY	0	Busy. Outputs a "L" level during playback and a "H" level when power is turned ON.
4 (58)	NAR	0	The CMD and ST Inputs become effective when high. NAR indicates whether the address bus (10 through 16) is ready to accept another address. When high, it is ready to accept. NAR goes high when power is turned ON.
5 (59)	AOUT	0	Analog Speech Output. D/A converter output or LPF output is selected by entering the command.
10 (64)	XT	I	Ceramic Oscillator Input. This pin has an internal 0.5 to 5 M $\Omega$ feedback resistor between XT and $\overline{\text{XT}}$ . If an external clock is used, this is the clock input pin.
11 (1)	XT	0	Ceramic Oscillator Output. If an external clock is used, leave this pin open.
13 (3)	CMD	I	Command Input and Option Control. This pin is used as command and option input when CMD is at the high level with $\overline{ST}$ low. If this pin is not used or serial input is optioned, set this pin to "H" level This pin has an Internal pull up resistor.
14 (4)	ST	I	Start. Speech playback starts at the fall of the $\overline{ST}$ pulse. The 10-16 addresses are latched at the rise of the $\overline{ST}$ pulse. Input a $\overline{ST}$ pulse when NAR goes to the high level for channels 1 and 2. This pin has an internal pull-up resistor.
28 (18)	CH	I	Channel Control. Channel 1 is selected when the input Is pulled high. Channel 2 is selected when the Input is low. This pin has an internal pull-up resistor.
27 (17)	16/SD	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is serial data (command and address) input when serial input is optioned.
26 (16)	I5/SI	I	This pin is command and user-defined phrase input when parallel input is optioned. This pin is used as serial clock input when serial input is optioned.
25 (15)	14	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.
24 (14)	I3/PORT1	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.
23 (13)	I2/PORT0	I/O	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, this pin is a port output. The port output is controlled by entering external silence insertion code.
21, 22 (11, 12)	10, 11	I	This pin is command and user-defined phrase input when parallel input is optioned. When serial input is optioned, set this pin to "L" level. This pin has an internal pull-down resistor.

Pin	Symbol	Type	Description			
6 (60)	AGND		Analog ground pin.			
7 (61)	DGND	_	Digital ground pin.			
8 (62)	$AV_{DD}$	_	Analog power pin. Insert a 0.1 $\mu\text{F}$ or more bypass capacitor between this pin and AGND.			
9 (63)	$DV_{DD}$	_	Digital power pin. Insert a 0.1 $\mu\text{F}$ or more bypass capacitor between this pin and DGND.			
12 (2)	MCK	0	Main clock output pin. Use MCK as a connection pin for the MSC1192, etc. When the IC is standby status, MCK is held high.			
16 (6)	CPU	I	CPU Mode. Set to "H" level to select Microcontroller Interface mode.			
17 (7)	SERIAL	I	Serial/Parallel Interface Select. This input selects either the parallel or the serial input interface. The serial input interface is selected with a high level; the parallel input interface is selected with a low level.			
30 (20)	CE	0	Chip Enable. $\overline{\text{CE}}$ is a timing output pin to control read of external memory. This pin outputs when $\overline{\text{RCS}}$ is at the "L" level. This pin outputs "H" level when $\overline{\text{RCS}}$ is at the "H" level.			
31 (21)	RCS	I	Read Chip Select. The data bits D0-D7 are internally pulled down when $\overline{RCS}$ is high. Addresses and $\overline{CE}$ are output when $\overline{RCS}$ is at "L" level. The RA22-RA0 address pins become high impedance and $\overline{CE}$ pin outputs "H" level when $\overline{RCS}$ is at the "H" level.			
32, 34- 40 (22, 24- 30)	D0-D7	I	External Memory Data Bus. Data is input when RCS is low. When RCS is high, these pins become low due to internal pull-down resistors.			
41-63 (31-40, 42-54)	RA0-RA22	0	External Memory Address. These are address pins for an external memory output when $\overline{RCS}$ is low. These pins become high impedance status if $\overline{RCS}$ is in "H" level.			
15, 64 (5, 55)	TEST1, 2	I	Test. Set these pins to "H" level.			
18 (8)	ĪBUSY	0	Outputs a "L" level during playback or when AOUT is at 1/2 $\rm V_{\rm DD}$ (except standby conversion)			
20 (10)	STANDBY	0	Outputs a "L" level during which the device is oscillating.			

## ABSOLUTE MAXIMUM RATINGS

(GND = 0 V)

Parameter	Symbol	Condition	Rating	Unit
Power supply voltage	$V_{DD}$	T- 25°C	-0.3 to +7.0	V
Input voltage	V <sub>IN</sub>	Ta = 25°C	$-0.3$ to $V_{DD} + 0.3$	V
Storage temperature	T <sub>STG</sub>	_	-55 to +150	°C

## RECOMMENDED OPERATING CONDITIONS

(GND = 0 V)

Parameter	Symbol	Condition	Range			Unit	
Power supply voltage	$V_{DD}$	MSM6652-56, MSM6650, V <sub>DD</sub> MSM6652A-56A		2.4 to 5.5		V	
		MSM6658A, MSM66P54/P56 3.5 to 5.5			٧		
Operating temperature	T <sub>OP</sub>	_		-40 to +85		°C	
Master clock frequency	food		Min.	Тур.	Max.	MHz	
Master clock frequency	Tosc		3.5	4.096	4.5	IVII IZ	

## **ELECTRICAL CHARACTERISTICS**

#### **DC** Characteristics

 $(V_{DD} = 5.0 \text{ V}, \text{ GND} = 0 \text{ V}, \text{ Ta} = -40 \text{ to } +85^{\circ}\text{C})$ 

		0 1111		_		
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
High level input voltage	$V_{IH}$		4.2	_		V
Low level input voltage	$V_{IL}$		_	_	0.8	V
High level output voltage	V <sub>OH</sub>	$I_{OH} = -1 \text{ mA}$	4.6	_		V
Low level output voltage	V <sub>OL</sub>	I <sub>OL</sub> = 2 mA	_	_	0.4	V
High level input current 1	I <sub>IH1</sub>	$V_{IH} = V_{DD}$	_	_	10	μА
High level input current 2	I <sub>IH2</sub>	Internal pull-down resistor	30	90	200	μΑ
Low level input current 1	I <sub>IL1</sub>	$V_{IL} = GND$	-10	_	_	μΑ
Low level input current 2 *1	I <sub>IL2</sub>	Internal pull-up resistor	-200	-90	-30	μΑ
Operating current	I <sub>DD</sub>		_	6	10	mA
Standby ourront	I <sub>DS</sub>	$Ta = -40^{\circ}C \text{ to } +50^{\circ}C$	_	_	10	μΑ
Standby current		Ta = -40°C to $+85$ °C	_	_	30	μΑ
D/A output relative accuracy	V <sub>DAE</sub>	When D/A output selected	_	_	40	mV
D/A output impedance	В	When D/A output selected *2	15	25	35	kΩ
D/A output impedance	$R_{DAO}$	When D/A output selected *3	15	30	45	kΩ
LPF driving resistance	R <sub>AOUT</sub>	When LPF output selected	50			kΩ
LPF output impedance	R <sub>LPF</sub>	$I_F = 100  \mu A$	_	1	3	kΩ

<sup>\*1.</sup> Applied to RESET, CMD, ST, CH.

#### **DC** Characteristics

 $(V_{DD} = 3.1 \text{ V, GND} = 0 \text{ V, Ta} = -40 \text{ to } +85^{\circ}\text{C})$ 

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
High level input voltage	$V_{IH}$	<del>_</del>	2.7	_	_	V
Low level input voltage	$V_{IL}$	_		_	0.5	V
High level output voltage	$V_{OH}$	$I_{OH} = -1 \text{ mA}$	2.6	_	_	V
Low level output voltage	$V_{OL}$	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V
High level input current 1	I <sub>IH1</sub>	$V_{IH} = V_{DD}$	_	_	10	μΑ
High level input current 2	I <sub>IH2</sub>	Internal pull-down resistor	10	30	100	μΑ
Low level input current 1	$I_{\rm IL1}$	$V_{IL} = GND$	-10	_	_	μΑ
Low level input current 2 (Note)	I <sub>IL2</sub>	Internal pull-up resistor	-100	-30	-10	μΑ
Operating current	I <sub>DD</sub>	_	_	4	7	mA
Standby ourrant		Ta = -40°C to +50°C		—	5	μΑ
Standby current	I <sub>DS</sub>	Ta = -40°C to $+85$ °C		_	20	μΑ
D/A output relative accuracy	$ V_{DAE} $	When D/A output selected	_	_	20	mV
D/A output impedance	$R_{DAO}$	When D/A output selected	15	25	35	kΩ
LPF driving resistance	R <sub>AOUT</sub>	When LPF output selected	50	_	_	kΩ
LPF output impedance	$R_{LPF}$	$I_F = 100 \mu A$		1	3	kΩ

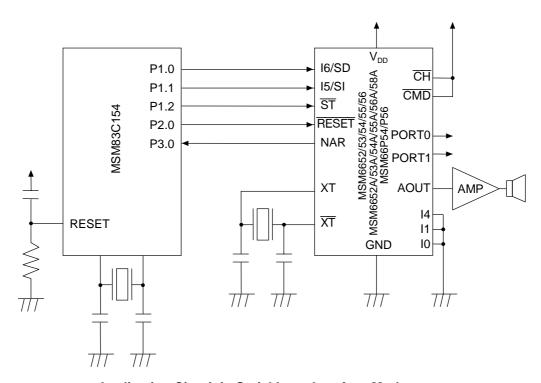
Note: Applied to RESET, CMD, ST, CH.

<sup>\*2.</sup> Applied to MSM6652/53/54/55/56, MSM6652A/53A/54A/55A/56A/58A, MSM6650.

<sup>\*3.</sup> Applied to MSM66P54/P56.

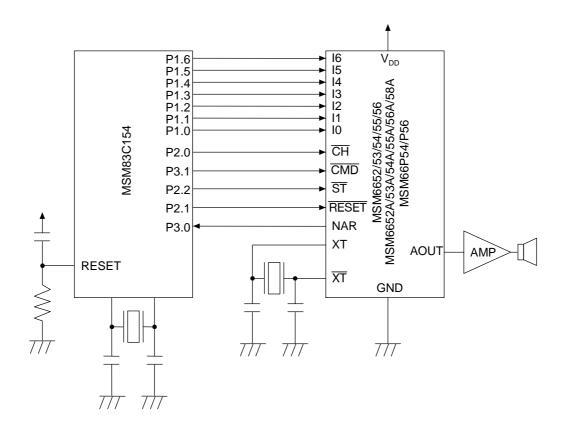
## APPLICATION CIRCUITS

 $(MSM6652/53/54/55/56-xxx,\,MSM6652A/53A/54A/55A/56A/58A-xxx,\,MSM66P54/P56-xx)$ 



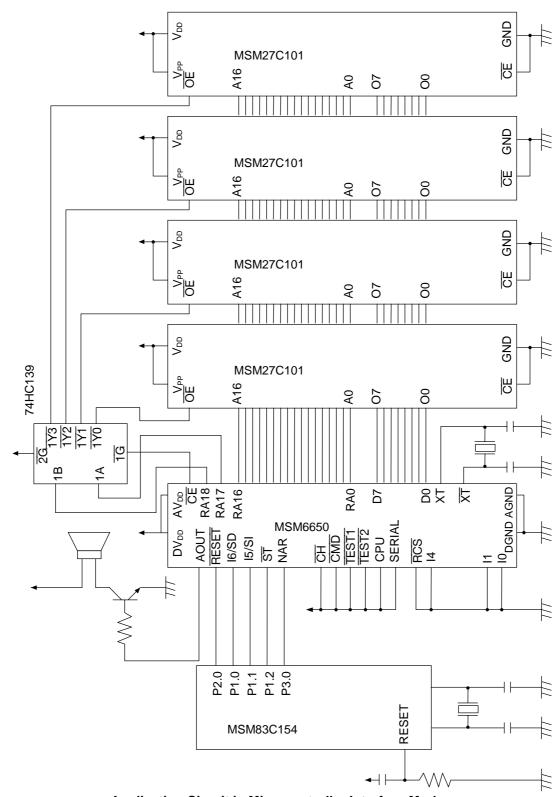
**Application Circuit in Serial Input Interface Mode** 

(MSM6652/53/54/55/56-xxx, MSM6652A/53A/54A/55A/56A/58A-xxx, MSM66P54/P56-xx)



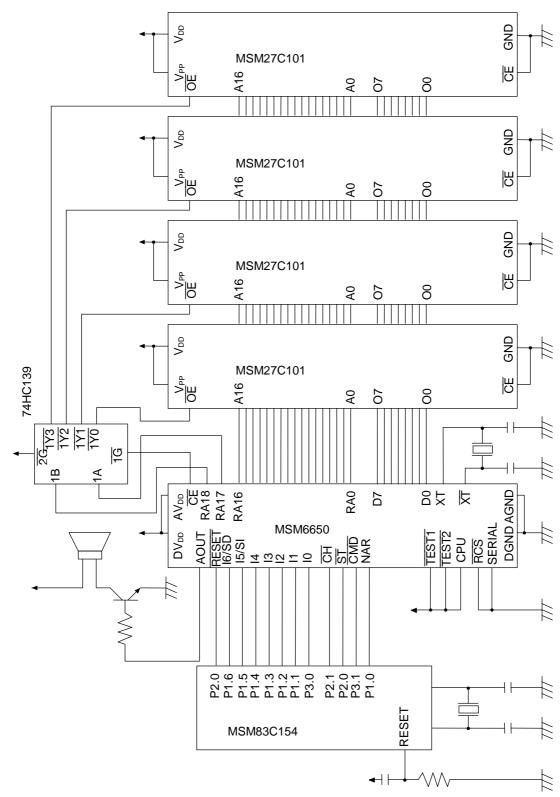
**Application circuit in Parallel Input Interface Mode** 

## (MSM6650)



Application Circuit in Microcontroller Interface Mode Using Four 1-Mbit EPROMs (Serial Input Interface)

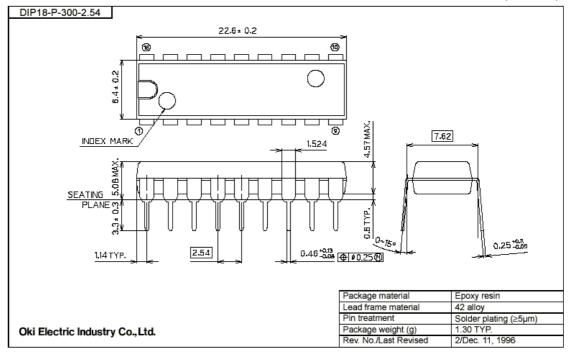
## (MSM6650)

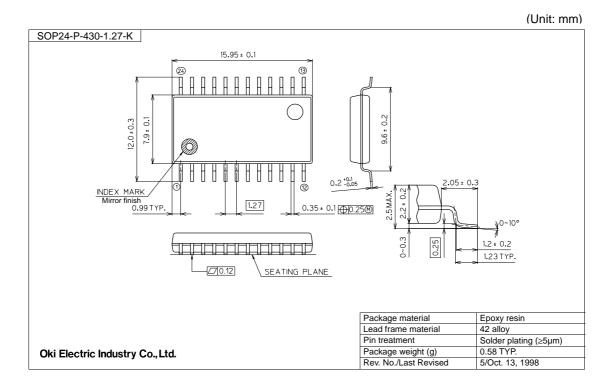


Application Circuit in Microcontroller Interface Mode Using Four 1-Mbit EPROMs (Parallel Input Interface)

## PACKAGE DIMENSIONS

(Unit: mm)



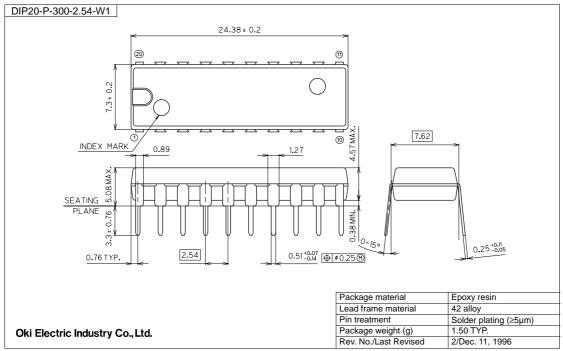


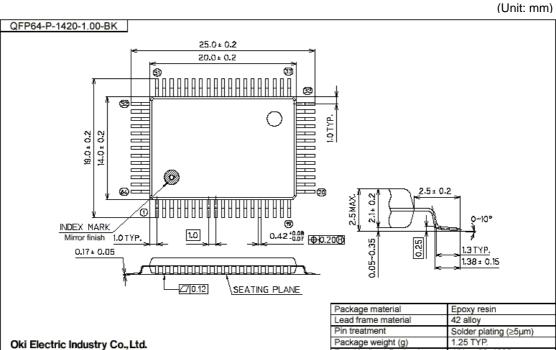
Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).







4/Nov. 28, 1996

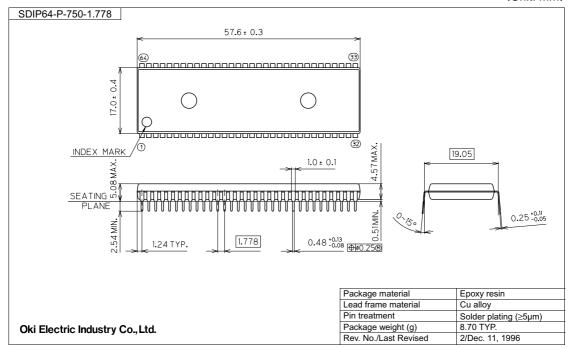
Rev. No./Last Revised

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## (Unit: mm)



## **REVISION HISTORY**

Document		Page			
No.	Date	Previous Edition	Current Edition	Description	
FEDL6650DIGEST-04	Jul. 2000	-	-	Edition 4	
EEDLOCEODICECT OF	Jan. 11,	14	14	Madified descriptions of CC and DCC	
FEDL6650DIGEST-05	2002	33	33	Modified descriptions of $\overline{\text{CS}}$ and $\overline{\text{RCS}}$ .	

#### **NOTICE**

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